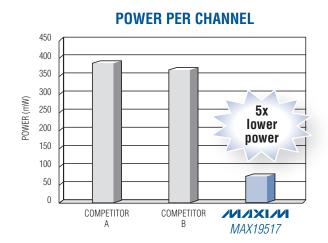


Industry's lowest power, dual-channel 10-bit, 130Msps ADC has superior dynamic performance

Extensive feature set minimizes external component count

The MAX19517 ADC is a member of Maxim's pin-compatible family of ultra-low-power, dual-channel ADCs. Its extensive set of features (a partial list is shown below) minimizes external component count and supports a wide range of applications that demand high performance.

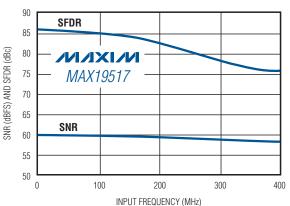


- Lowest power: 75mW per channel
- Excellent performance for input frequencies from DC to > 400MHz
- Self-sensing supply regulation
- 1.8V, 2.5V, 3.3V operation
- Wide input common-mode range

Pin-compatible, ultra-low-power, dual-channel ADCs

Part	Resolution (Bits)	Sample Rate (Msps)	Power per Channel (mW)	SNR (dBFS)	SFDR (dBc)
MAX19517	10	130	75	60.0	85
MAX19516	10	100	57	60.0	85
MAX19515	10	65	43	60.0	85
MAX19507*	8	130	75	49.7	69
MAX19506*	8	100	57	49.7	69
MAX19505*	8	65	43	49.7	69

DYNAMIC PERFORMANCE



- Programmable CMOS termination
- Flexible data formatting
- Programmable data timing
- Programmable clock divider: 1x, 2x, 4x
- Data output test patterns
- 7mm x 7mm, 48-pin TQFN package

See inside	Page
High-speed ADCs	1-4
High-speed DACs	5-9
Analog front-ends	10
Selection guide	

*Future product—contact factory for availability.

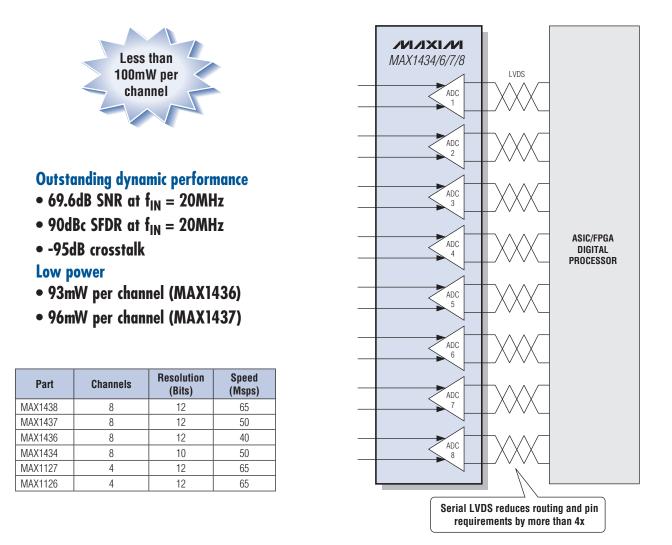
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Low-power, octal, 12-bit 40/50/65Msps ADCs Serial LVDS ADCs offer space-saving solution with outstanding 90dBc SFDR

Maxim expands its high-performance, ultra-low-power, MAX1126/MAX1127 quad 12-bit ADC family by offering the MAX1436/MAX1437/MAX1438 family of pin-compatible octal ADCs. These octal ADCs are ideal for high-channel-count applications with demanding performance, power, and space requirements, such as medical imaging and wireless communications.

To address the high-density requirements, these quad/octal ADCs offer the choice of either a serial low-voltage differential signaling (LVDS) interface or a serial scalable low-voltage signaling (SLVS) interface. The serial LVDS/ SLVS interface significantly reduces pin count, resulting in a smaller package and a compact digital interface.



To speed designs, obtain an EV kit at: www.maxim-ic.com/hscMAX1438EVKIT

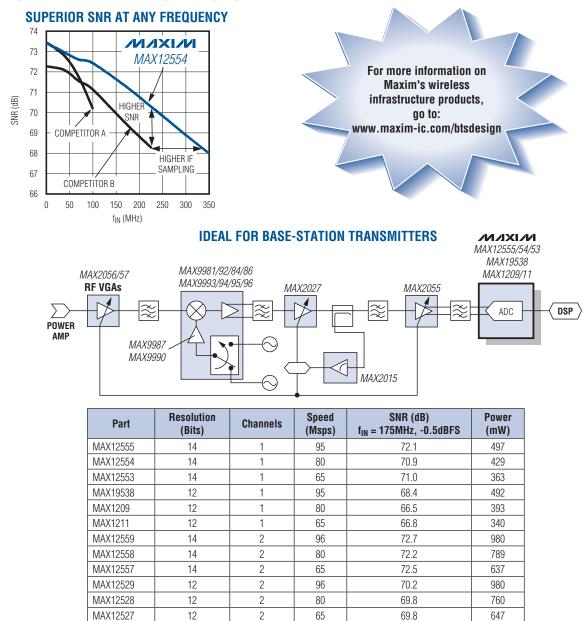


14-/12-bit, 95Msps ADCs deliver 72.1dB SNR at 175MHz and 497mW

High-speed, single/dual, direct IF-sampling ADCs simplify system design and reduce cost

The MAX12555/MAX12554/MAX12553 single 14-bit ADCs are optimized for lower power and high dynamic performance in IF-sampling applications such as communications receivers, medical imaging, instrumentation, and data acquisition. For example, the MAX12555 delivers 72.1dB SNR at an input frequency of 175MHz while consuming only 497mW. These ADCs are capable of direct IF sampling up to 400MHz, which simplifies system design and reduces cost by eliminating downconversion stages. Pin-compatible, 12-bit versions are offered for additional design flexibility.

The MAX12559/MAX12558/MAX12557/MAX12529/MAX12528/MAX12527 integrate two ADC channels into one package. These dual 14-/12-bit ADCs offer similar performance to the single ADCs, and are ideal for I/Q sampling or for main and diversity IF sampling.





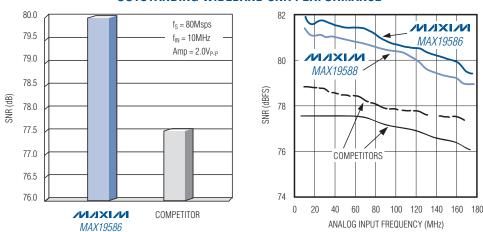
14-/12-bit ADCs

the best noise floor at -82dBFS

Outstanding dynamic performance at low power

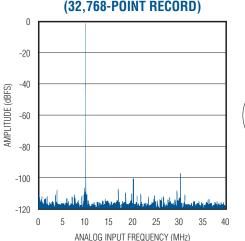
The MAX19586 (16-bit, 80Msps ADC) and the MAX19588 (16-bit, 100Msps ADC) are designed for applications that demand very high dynamic range and excellent spurious performance. Ideal applications are cellular base-station receiver systems, multicarrier and multistandard communication receivers, E911 location receivers, antenna-array processing, and high-end test and measurement instrumentation.

These two ADCs are in the elite class of ADCs that achieve 80dB or more of SNR. They provide this 80dB SNR at an input frequency of 10MHz, as well as a -82dBFS noise floor and 96dBc SFDR.



OUTSTANDING WIDEBAND SNR PERFORMANCE

- Outstanding dynamic performance
 -82dBFS noise floor
 - 80dB SNR at $f_{IN} = 10MHz^*$
 - 78.5dB SNR at $f_{IN} = 100MHz^*$
 - 96dBc SFDR at $f_{IN} = 10MHz^*$
 - 84dBc SFDR at $f_{IN} = 100MHz^*$
- Low power: 1.1W*
- Ideal for multicarrier receivers, multistandard receivers, and high-performance instrumentation



FFT PLOT

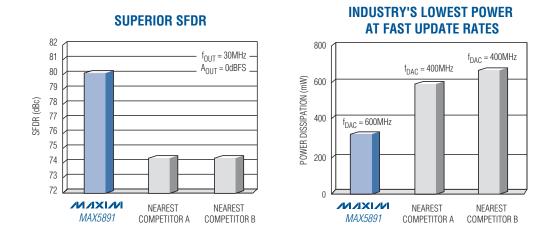


www.maxim-ic.com/hscMAX19586 or www.maxim-ic.com/hscMAX19588

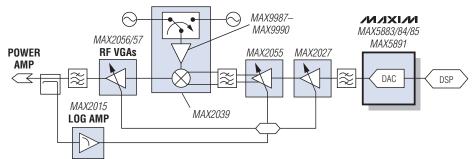
*MAX19586, $f_{s} = 80Msps$

High-speed, 16-/14-/12-bit DACs are ideal for broadband communications 16-bit, 600Msps DAC delivers best SFDR, IMD at the lowest power

The MAX5891 and MAX5885 high-speed DAC families deliver outstanding spurious-free and noise-density performance, while offering 600Msps/200Msps update rates at very low power consumption. These devices are designed for single-/multicarrier communication systems (cellular base stations, microwave point-to-point links), instrumentation, and automated test equipment.



IDEAL FOR BASE-STATION TRANSMITTERS



- Outstanding dynamic performance
 - SFDR: 80dBc at f_{OUT} = 30MHz
 - Noise density: -163dBFS/Hz at f_{OUT} = 36MHz
 - Two-tone IMD: -95dBc at f_{OUT} = 30MHz
 - ACLR: 73dB at f_{OUT} = 122.88MHz
- Low-power: 298mW at 600Msps
- Pin-compatible, 16-/14-/12-bit LVDS and CMOS families
- Evaluation kits available

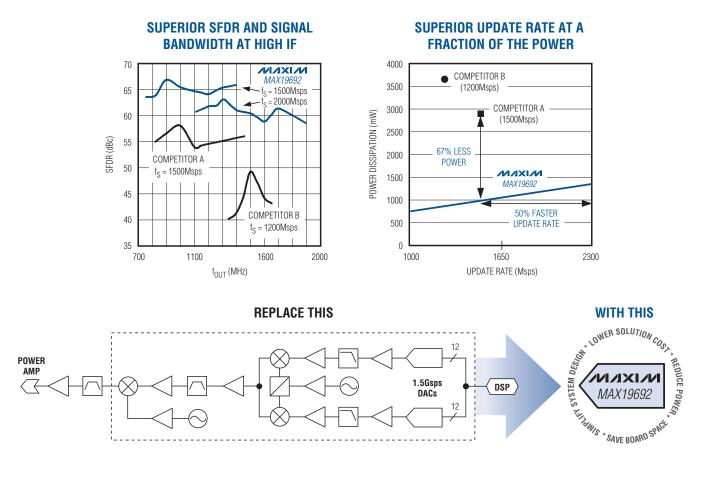
Part	Resolution (Bits)	DAC Update Rate (Msps)	SFDR (dBc) f _{out} = 30MHz	Noise Density (dBFS/Hz)	Input Interface
MAX5891	16		80	-163 at 36MHz	
MAX5890	14	600	80	-162 at 36MHz	LVDS
MAX5889	12		79	-157 at 36MHz	
MAX5885	16		71	-155 at 16MHz	
MAX5884	14	200	66	-153 at 16MHz	CMOS
MAX5883	12		66	-150 at 16MHz	

www.maxim-ic.com/hscMAX5891



12-bit, 2.3Gsps multi-Nyquist DAC delivers industry's best SFDR at high IF Enables wideband and direct RF communications at one-third the power

The MAX19692 12-bit, 2.3Gsps DAC synthesizes wideband signals (up to 1GHz bandwidth) in baseband and in higher Nyquist zones (from DC to more than 2GHz) with excellent spurious and noise performance. This DAC has a high SNR and excellent gain flatness in the first three Nyquist zones directly, thus eliminating the need for upconversion stages in a radio transmitter. With its unique ability to generate broadband signals over a wide frequency range, the MAX19692 enables ultra-high-data-rate wireless modems, multistandard software radio transmitters, wideband radar, arbitrary waveform generators, and automatic test equipment (ATE) applications.



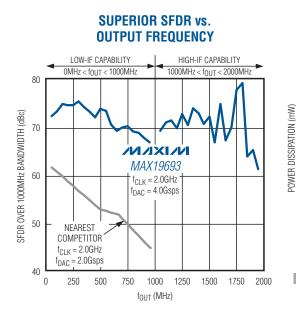
- Industry's highest dynamic performance
 - Noise spectral density = -162dBm/Hz at f_{OUT} = 200MHz
 - SFDR = 75dBc at f_{OUT} = 200MHz
 - SFDR = 73dBc at $f_{OUT} = 600$ MHz
 - SFDR = 65dBc at $f_{OUT} = 1300$ MHz
 - SFDR = 60dBc at f_{OUT} = 1800MHz

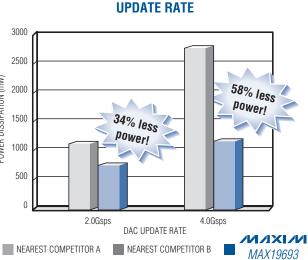
- 2.3Gsps output-update rate
 Synthesizes 1GHz signal bandwidth
- 4:1 multiplexed LVDS inputs
- Low power: 760mW at 1Gsps
- 11mm x 11mm, 169-pin CSBGA package
- Data source (FPGA) board available
- Evaluation kit available



12-bit, 4.0Gsps wideband DAC delivers best dynamic performance with lowest power Simplifies design of wideband communications, instrumentation, and military applications

The MAX19693 12-bit, 4.0Gsps DAC synthesizes wideband signals (up to 2GHz bandwidth) with excellent spurious and noise performance, while consuming the lowest power and space. As such, this DAC simplifies the design of wideband communications transmitters, radars, jammers, arbitrary waveform generators, ATE, and other commercial and military equipment.



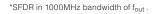


LOWEST POWER DISSIPATION vs.

- 4.0Gsps output-update rate
 - Low-IF and high-IF direct synthesis
- Industry's highest dynamic performance
 - Noise spectral density = -164dBm/Hz at f_{OUT} = 200MHz
 - SFDR* > 69dBc at $f_{OUT} < 800MHz$
 - SFDR = 70dBc at $f_{OUT} = 1700MHz$

- Low power: 1.2W at 4.0Gsps
- 4:1 multiplexed LVDS inputs
- 11mm x 11mm, 169-pin CSBGA package— 20x smaller than the competition
- -40°C to +85°C extended temperature range
- Data source (FPGA) board available
- Evaluation kit available

www.maxim-ic.com/hscMAX19693

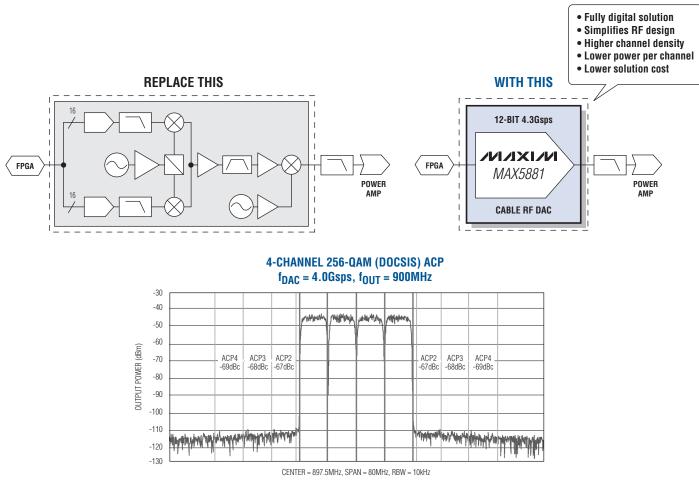




12-bit DAC

12-bit, 4.3Gsps RF DAC directly synthesizes four QAM channels in 50MHz to 1000MHz cable downstream band Enables fully digital upconverter for DOCSIS® 3.0-compliant edge QAM devices and cable modem termination systems (CMTS)

The MAX5881 12-bit, 4.3Gsps RF DAC directly synthesizes multichannel QAM signals in the 50MHz to 1000MHz cable downstream band, and meets the requirements of DOCSIS 3.0 for up to four contiguous channels per RF port. This DAC not only simplifies the RF portion of an upconverter design, but also provides higher density, lower power, and lower cost per channel than the traditional analog approach.



- Industry-leading dynamic performance
 - Supports up to four 6MHz* QAM channels
 - ACP2 = -67dBc at f_{OUT} = 1000MHz (6MHz offset)
 - ACP3 = -68dBc at f_{OUT} = 1000MHz (12MHz offset)
 - ACP4 = -69dBc at f_{OUT} = 1000MHz (18MHz offset)
- Data source (FPGA) board available

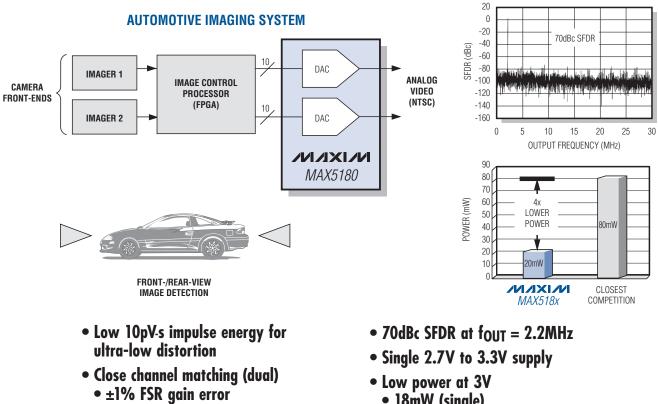
DOCSIS is a registered trademark of Cable Television Laboratories, Inc. (CableLabs®). *Supports EuroDOCSIS, 8MHz QAM channels.

- 4.3Gsps output-update rate
 - Direct RF synthesis: 50MHz to 1000MHz
- Low power: 1.2W at 4.0Gsps
- 4:1 multiplexed LVDS inputs
- 11mm x 11mm, 169-pin CSBGA package
- Evaluation kit available



Low-power, 3V, dual 10-/8-bit DACs deliver 70dBc SFDR at 20mW Single/dual 40MHz DACs ideal for automotive imaging and communication applications

The MAX518x family of high-speed DACs features internal 50ppm/°C, low-noise, 1.2V references. These DACs meet the dynamic performance and low-power requirements of high-speed communication, signal synthesis, and imaging applications. The dual DACs accept interleaved data on a single digital-input bus and provide differential outputs in current or voltage format, updated simultaneously on each clock cycle. Alternate-phase-update output and single-channel DAC versions are available. These DACs are designed for the extended-industrial temperature range (-40°C < T_A < +85°C).*



- ±0.2° phase error
- Small package options • 24-pin QSOP/TQFN (single)
 - 28-pin QSOP (dual)

- 18mW (single)
- 20mW (dual)
- < 1µA shutdown and standby mode to conserve power
- Evaluation kits available

Part	Resolution (Bits)	DACs per Package	Output Update**	SFDR (dBc)	Gain Mismatch (%)	Phase Mismatch (Degrees)	Output Type
MAX5180/MAX5183		2	Simultaneous		±1	±0.2	lau=0/au=
MAX5181/MAX5184	10	1	—		—	—	
MAX5182/MAX5185		2	Alternate	70	—	—	
MAX5186/MAX5189		2	Simultaneous	70	±1	±0.2	I _{OUT} /V _{OUT}
MAX5187/MAX5190	8	1	—		_	_	
MAX5188/MAX5191		2	Alternate				

*Contact factory if alternative temperature range is required

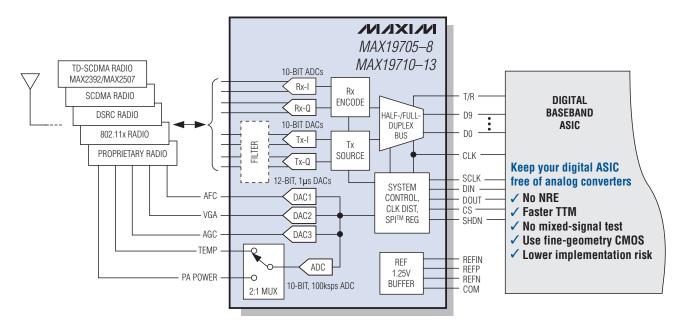
**Alternate-phase-update, dual-DAC versions available for applications requiring lowest latency



10-/8-bit DACs

Integrated AFEs offer lowest power, smallest size, and lowest cost Ideal for ZIF transceivers in handsets, PDAs, data cards, CPEs, and WLANs

Maxim expands its portfolio of half-duplex analog front-ends (AFEs), the MAX19705–MAX19708, with the MAX19710–MAX19713 full-duplex AFEs. These products have been designed for applications that demand good dynamic performance, ultra-low power, and a high level of integration. These AFEs offer integrated high-speed, 10-bit ADCs and DACs for the receive/transmit path. They also incorporate auxiliary low-speed, 12-bit DACs and a 10-bit ADC for various housekeeping control (e.g., gain) and measurement (e.g., temperature) functions. Typical applications for this family of AFEs include battery-powered wireless devices, PDAs, and cellular handsets.



High level of integration

- Tx: dual 10-bit DACs
- Rx: dual 10-bit ADCs
- Aux ADC/DACs, optional Tx filter
- Half-/full-duplex digital bus options
- Compact 7mm x 7mm x 0.8mm, 48-/56-pin TQFN package

Excellent dynamic performance

- > 54dB SINAD (Rx ADCs)
- > 70dBc SFDR (Tx DACs)

Ultra-low power and versatile control

- 28mW to 92mW (7.5Msps to 45Msps)
- Shutdown, idle, standby, Tx/Rx disable Lowest cost solution
- Save 56% over discrete solutions
- Pricing starts at less than \$5.00⁺



Ра	art	Speed	Features
Half-Duplex Bus	Full-Duplex Bus	(Msps)	rediules
MAX19705ETM	MAX19710ETN	7.5	Aux DAC, aux ADC
MAX19708ETM	MAX19711ETN	11	Aux DAC, aux ADC, LP Tx filters
MAX19706ETM	MAX19712ETN	22	Aux DAC, aux ADC
MAX19707ETM	MAX19713ETN	45	Aux DAC, aux ADC

SPI is a trademark of Motorola, Inc.

†50k-up recommended resale. Prices provided are for design guidance and are FOB USA. International prices will differ due to local duties, taxes, and exchange rates. Not all packages are offered in 1k increments, and some may require minimum order quantities.



High-Speed ADCs

Part	Resolution (Bits)	Sample Rate (Msps)	Input Channels	Data-Bus Interface	Supply Voltage (V)
MAX105	6	800	2	LVDS	5 and 3.3
MAX107	6	400	2	LVDS	5 and 3.3
MAX1003	6	90	2	CMOS	5 and 3.3
MAX1002	6	60	2	CMOS	5
MAX108	8	1500	1	PECL	±5
MAX104	8	1000	1	PECL	±5
MAX106	8	600	1	PECL	±5
MAX1121	8	250	1	LVDS	1.8
MAX19507*/6*/5*	8	130/100/65	2	CMOS	1.8 or 2.5 to 3.3
MAX1198/7/5	8	100/60/40	2	CMOS	3
MAX1196	8	40	2	CMOS, mux	3
MAX1193/2/1	8	45/22/7.5	2	CMOS, mux	3
MAX1124/3/2	10	250/210/170	1	LVDS	1.8
MAX1449/8/6/4	10	105/80/60/40	1	CMOS	3.3/3/3/3
MAX1425/6	10	20/10	1	CMOS	5 and 3.3
MAX1190	10	120	2	CMOS	3.3
MAX19517/6/5	10	130/100/65	2	CMOS	1.8 or 2.5 to 3.3
MAX1180/1/2/3/4	10	105/80/65/40/20	2	CMOS	3.3/3/3/3/3
MAX1186/5	10	40/20	2	CMOS, mux	3
MAX1434	10	50	8	LVDS	1.8
MAX1215/4/3	12	250/210/170	1	LVDS	1.8
MAX1215N/14N/13N	12	250/210/170	1	LVDS	1.8
MAX1219/8/7	12	210/170/125	2	LVDS	1.8
MAX19542/1	12	170/125	1	CMOS	1.8
MAX19538	12	95	1	CMOS	3.3
MAX1209/11	12	80/65	1	CMOS	3.3
MAX1208/7/6	12	80/65/40	1	CMOS	3.3
MAX12529/8/7	12	96/80/65	2	CMOS	3.3
MAX1127/6	12	65/40	4	LVDS	1.8
MAX1438/7/6	12	65/50/40	8	LVDS	1.8
MAX1420/1/2	12	60/40/20	1	CMOS	3
MAX12555/4/3	14	95/80/65	1	CMOS	3.3
MAX12559/8/7	14	96/80/65	2	CMOS	3.3
MAX1205	14	1	1	CMOS	5/3.3
MAX19588/6	16	100/80	1	CMOS	3.3

High-Speed DACs

Part	Resolution (Bits)	Update Rate (Msps)	DACs	Data-Bus Interface	Supply Voltage (V)
MAX5190/87	8	40	1	CMOS	2.7 to 5.5
MAX5186/88/89/91	8	40	2	CMOS	2.7 to 5.5
MAX5184/1	10	40	1	CMOS	2.7 to 5.5
MAX5180/2/3/5	10	40	2	CMOS	2.7 to 5.5
MAX5852/1	8	165/80	2	CMOS	3
MAX5854/3	10	165/80	2	CMOS	3
MAX5856A/58A	8/10	300	2	CMOS	3.3
MAX5883/4/5	12/14/16	200	1	CMOS	3.3
MAX5873/4/5	12/14/16	200	2	CMOS	1.8, 3.3
MAX5876/7/8	12/14/16	250	2	LVDS	1.8, 3.3
MAX5886/7/8	12/14/16	500	1	LVDS	3.3
MAX5893/4/5	12/14/16	500	2	CMOS	1.8, 3.3
MAX5898	16	500	2	LVDS	1.8, 3.3
MAX5889/90/91	12/14/16	600	1	LVDS	1.8, 3.3
MAX19692	12	2300	1	LVDS	1.8, 3.3
MAX19693	12	4000	1	LVDS	1.8, 3.3
MAX5881	12	4300	1	LVDS	1.8, 3.3

AFEs

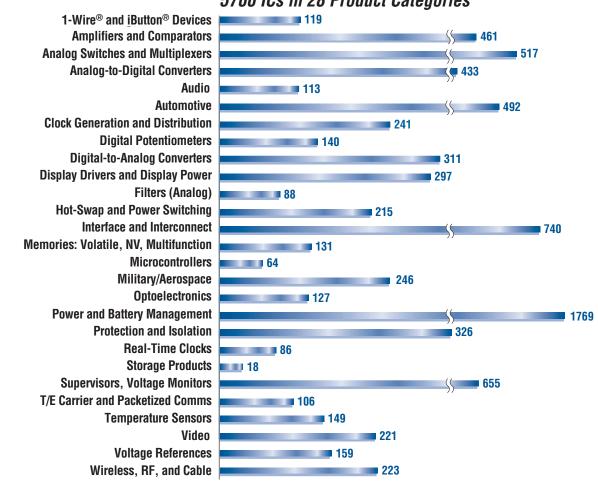
Part	ADCs (Bits)	ADC Sample Rate (Msps)	DACs (Bits)	DAC Update Rate (Msps)	Supply Voltage (V)
MAX5866/5/4/3	2 x 8	60/40/22/7.5	2 x 10	60/40/22/7.5	3.3
MAX19700	2 x 10	7.5	2 x 10	7.5	3.3
MAX19707/6/8/5	2 x 10	45/22/11/7.5	2 x 10	45/22/11/7.5	3.3
MAX19713/12/11/10	2 x 10	45/22/11/7.5	2 x 10	45/22/11/7.5	3.3

*Future product—contact factory for availability.

For pricing and availability, go to: www.maxim-ic.com/sales

A new IC every day

Maxim has one of the broadest and deepest analog and mixed-signal portfolios, with over 5700 ICs in 28 categories. We average more than one product introduction per day! For 25 years, we have delivered innovative engineering solutions that add value to our customers' products.



5700 ICs in 28 Product Categories

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